

FEATURES

- **LOW POWER CONSUMPTION:** 20 mW
- **WIDE BAND APPLICATION:** 0.5 to 1.7 GHz
- **SINGLE SUPPLY VOLTAGE:** $V_{CC} = 3\text{ V} \pm 10\%$
- **SMALL PACKAGE**
- **SUITABLE FOR HAND HELD (BATTERY) APPLICATIONS**

DESCRIPTION

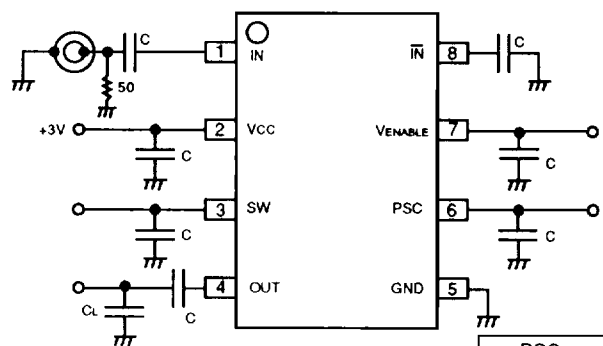
The UPB1502GR prescaler operates from 0.5 to 1.7 GHz at division ratios of 64, 65, 128 or 129. The 3 volt, 7 mA DC power requirements of this device make it highly desirable for hand-held, battery-operated systems. The low cost 8-pin plastic package is suitable for surface mount applications.

RECOMMENDED

OPERATING CONDITIONS ($T_A = 25^\circ\text{C}$)

SYMBOL	PARAMETER	UNITS	RATINGS
V_{CC}	Supply Voltage	V	3.0 ± 0.3
TOP	Operating Temperature	$^\circ\text{C}$	-40 to +85

TEST CIRCUIT



		PSC	
		V_{CC}	GND
SW	V_{CC}	1/64	1/65
	Open/GND	1/128	1/129

Notes:

1. All Capacitors 1000 pF except load capacitor on output should be 8 pF. Capacitors on SW and PSC are not required if these pins are grounded.
2. Connect VENABLE pin to +3 volts for normal operation. Connect to GND to disable device.
3. To minimize self-oscillation, circuit board traces to the input and output pins should be isolated from each other as much as possible.

ELECTRICAL CHARACTERISTICS ($T_A = -40$ to $+85^\circ\text{C}$, $V_{CC} = 2.7$ to 3.3 V)

PART NUMBER PACKAGE OUTLINE			UPB1502GR, UPB1502GR(1) G08		
SYMBOLS	PARAMETERS AND CONDITIONS	UNITS	MIN	TYP	MAX
I_{CC}	Supply Current $V_{ENABLE} = V_{CC}$ $V_{ENABLE} \leq 0.8\text{ V}$	mA μA	3.2	6.7 5	11.0 20
f_{IN}	Input Frequency at $P_{IN} = -15$ to -11 dBm (UPB1502GR) $P_{IN} = -11$ to -6 dBm (UPB1502GR) $P_{IN} = -6$ to 0 dBm (UPB1502GR) $P_{IN} = -15$ to -14 dBm (UPB1502GR(1)) $P_{IN} = -14$ to -11 dBm (UPB1502GR(1)) $P_{IN} = -11$ to -9 dBm (UPB1502GR(1)) $P_{IN} = -9$ to -1 dBm (UPB1502GR(1)) $P_{IN} = -1$ to 0 dBm (UPB1502GR(1))	GHz	0.8 0.5 0.5 0.8 0.8 0.5 0.5 0.5		1.7 1.7 1.5 1.7 2.0 2.0 1.7 1.5
P_{IN}	Input Power at $f_{IN} = 0.5$ to 0.8 GHz $f_{IN} = 0.8$ to 1.5 GHz $f_{IN} = 1.5$ to 1.7 GHz (UPB1502GR) $f_{IN} = 1.5$ to 1.7 GHz (UPB1502GR(1)) $f_{IN} = 1.7$ to 2.0 GHz (UPB1502GR(1))	dBm	-11 -15 -15 -15 -14		0 0 -6 -1 -9
V_{OUT}	Output Voltage Swing, $C_L = 8\text{ pF}$	V _{PP}	0.8	1.1	
V_{MH}	Modulus Control, Input High (PSC)	V	2.5		
V_{ML}	Modulus Control, Input Low (PSC)	V			0.8
V_{DH}	Divide Ratio Control, Input High (SW)	V	V_{CC}		
V_{DL}	Divide Ratio Control, Input Low (SW) ¹	V		OPEN	
T_{SET}	Modulus Set-up Time (PSC) $f_{IN} = 1.7\text{ GHz}$	ns		11	
$R_{TH(CH-A)}$	Thermal Resistance (Channel to Ambient)	$^\circ\text{C/W}$			260

Note:

1. GND is acceptable.

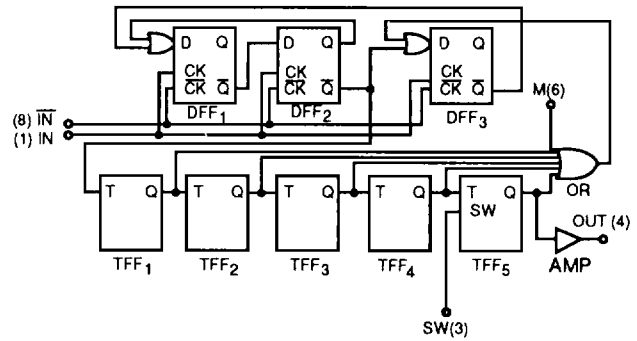
ABSOLUTE MAXIMUM RATINGS¹ (TA = 25°C)

SYMBOLS	PARAMETERS	UNITS	RATINGS
VCC	Supply Voltage	V	-0.5 to 6.0
VIN	Input Voltage	V	-0.5 to VCC + 0.5
PT	Total Power Dissipation ²	mW	250
TOP	Operating Temperature	°C	-40 to +85
TSTG	Storage Temperature	°C	-65 to +150

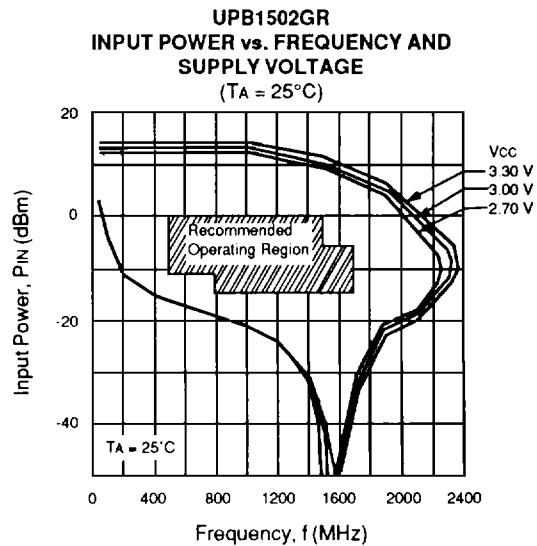
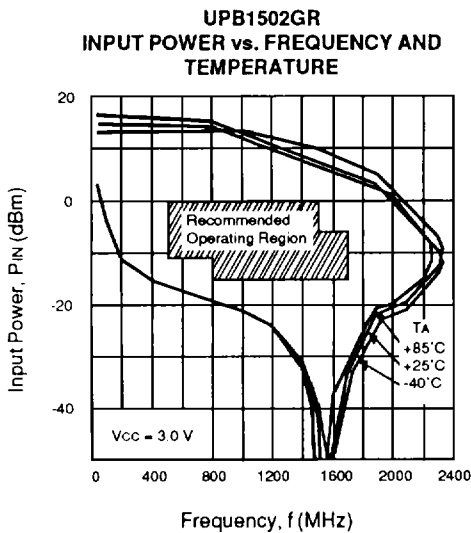
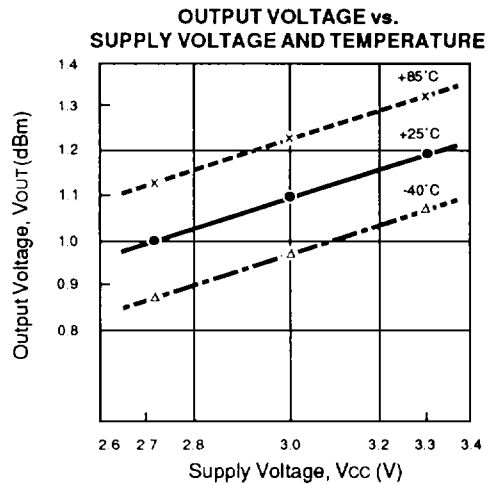
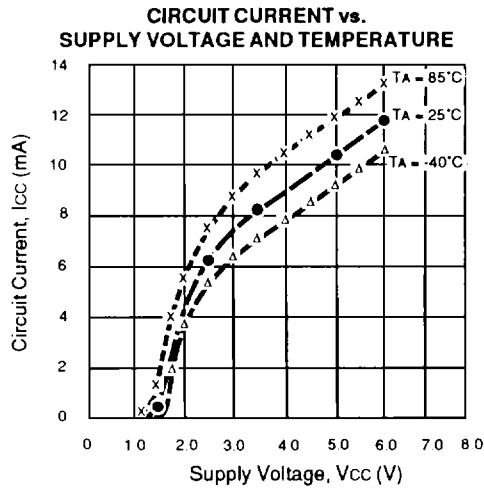
Notes:

1. Operation above any one of these parameters may result in permanent damage.
2. Mounted on 50 x 50 x 1.6 mm epoxy glass circuit board, (TA = 85°C)

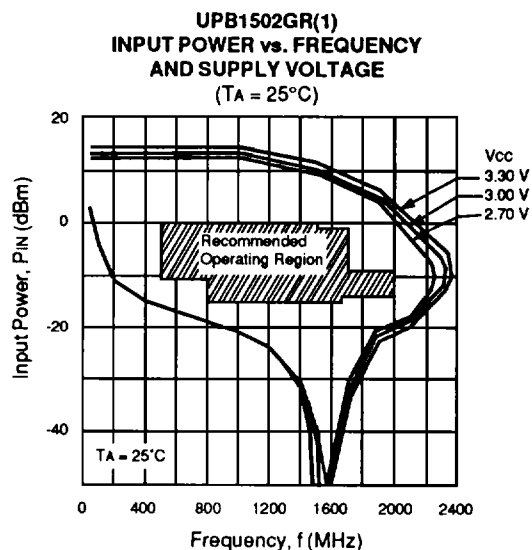
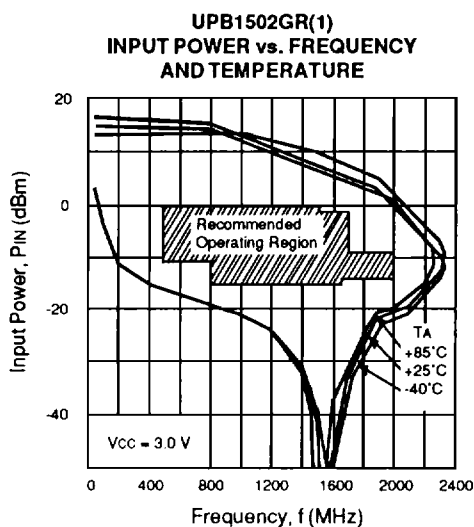
INTERNAL BLOCK DIAGRAM



TYPICAL PERFORMANCE CURVES



TYPICAL PERFORMANCE CURVES



TYPICAL SCATTERING PARAMETERS (TA = 25°C)

Divide-by-sixty-four mode
Vcc = 3.0 V, Icc = 6.7 mA

SW = High, PSC = High

FREQUENCY (MHz)	S ₁₁	
	MAG	ANG
250	0.811	-13
500	0.778	-26
750	0.733	-41
1000	0.654	-54
1250	0.585	-68
1500	0.511	-82
1750	0.484	-95
2000	0.462	-116
2250	0.447	-144
2500	0.430	-173

FREQUENCY (MHz)	S ₂₂	
	MAG	ANG
50	0.976	-6
100	0.924	-12
150	0.817	-17
200	0.733	-16
250	0.693	-15

Divide-by-one-twenty-eight mode
Vcc = 3.0 V, Icc = 6.7 mA

SW = Low, PSC = High

FREQUENCY (MHz)	S ₁₁	
	MAG	ANG
250	0.801	-13
500	0.767	-26
750	0.724	-41
1000	0.637	-54
1250	0.573	-68
1500	0.505	-82
1750	0.474	-96
2000	0.459	-116
2250	0.442	-145
2500	0.425	-172

FREQUENCY (MHz)	S ₂₂	
	MAG	ANG
50	0.980	-6
100	0.921	-13
150	0.801	-18
200	0.712	-18
250	0.666	-16

Divide-by-sixty-five mode
Vcc = 3.0 V, Icc = 6.7 mA

SW = High, PSC = Low

FREQUENCY (MHz)	S ₁₁	
	MAG	ANG
250	0.810	-13
500	0.775	-26
750	0.731	-41
1000	0.652	-55
1250	0.579	-68
1500	0.501	-82
1750	0.465	-96
2000	0.454	-116
2250	0.436	-144
2500	0.420	-174

FREQUENCY (MHz)	S ₂₂	
	MAG	ANG
50	0.972	-6
100	0.924	-12
150	0.817	-17
200	0.733	-16
250	0.693	-15

Divide-by-one-twenty-nine mode
Vcc = 3.0 V, Icc = 6.7 mA

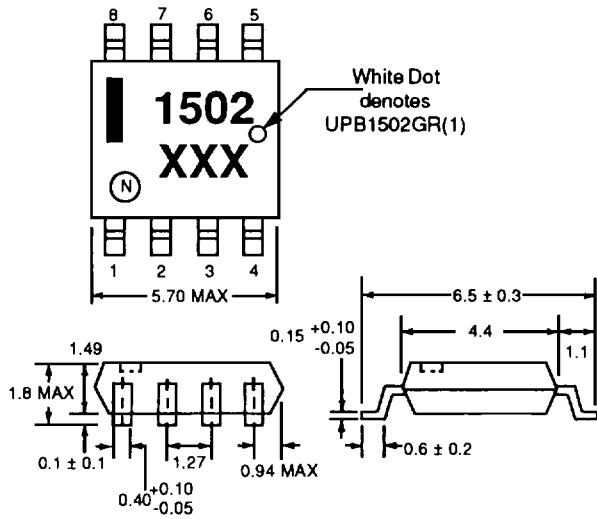
SW = Low, PSC = Low

FREQUENCY (MHz)	S ₁₁	
	MAG	ANG
250	0.804	-13
500	0.769	-26
750	0.727	-41
1000	0.650	-54
1250	0.581	-68
1500	0.508	-82
1750	0.467	-96
2000	0.452	-115
2250	0.435	-144
2500	0.413	-171

FREQUENCY (MHz)	S ₂₂	
	MAG	ANG
50	0.981	-6
100	0.921	-13
150	0.801	-18
200	0.712	-17
250	0.667	-16

OUTLINE DIMENSIONS (Units in mm)

**UPB1502GR
PACKAGE OUTLINE G08**



Lead Material: Alloy 42
Lead Plating: Lead-Tin Alloy

PIN	CONNECTION	DESCRIPTION
1.	IN	Signal Input
2.	Vcc	DC Supply Voltage
3.	SW	Divide Ratio Control*
4.	OUT	Signal Output
5.	GND	Ground
6.	PSC	Modulus Control*
7.	STBY	Stand By Operation*
8.	$\overline{\text{IN}}$	Signal Input Reference

* See Application Circuit

ORDERING INFORMATION

PART NUMBER	QUANTITY
UPB1502GR-E1	2500/REEL
UPB1502GR(1)-E1	2500/REEL

Note:
Embossed tape, 12 mm wide.
Pins 1-4 are in tape pull-out direction.